

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



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**Explosive atmospheres –  
Part 11: Equipment protection by intrinsic safety "i"**

**Atmosphères explosives –  
Partie 11: Protection de l'appareil par sécurité intrinsèque "i"**



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Part 11: Equipment protection by intrinsic safety "i"**

**Atmosphères explosives –  
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ELECTROTECHNICAL  
COMMISSION

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## EXPLOSIVE ATMOSPHERES –

### Part 11: Equipment protection by intrinsic safety "i"

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